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(12) **United States Design Patent**
Phillips et al.

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(45) **Date of Patent:** **** Jul. 21, 2015**

(54) **SENSOR MODULE**

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Suwon-si (KR)

(**) Term: **14 Years**

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(51) **LOC (10) Cl.** **10-04**

(52) **U.S. Cl.**

USPC **D10/103**; D11/3

(58) **Field of Classification Search**

USPC D10/30–39, 65, 70, 78, 97, 98, 103;
D11/3; D13/173–177; D14/138 R,
D14/203.5, 247, 338–340, 344, 346, 347;
D24/167, 168

CPC G08G 1/096883; G08G 1/096872;
G08G 1/096775; G01C 21/16; G01C 21/3688;
G01C 21/30; G01V 8/20; G01J 5/02; G01J
5/023; G01J 5/24; G01J 5/10; G01J 5/20;
G01J 5/0235; G01J 5/08; G01J 5/0853;
G01J 5/33; G01J 5/34

See application file for complete search history.

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(57) **CLAIM**

The ornamental design for a sensor module, as shown and described.

DESCRIPTION

This application makes reference to:
U.S. Design application Ser. No. 29/491,674 filed May 22, 2014.

The above referenced application, and all of the subject matter disclosed therein, is incorporated herein by reference in its entirety.

FIG. 1 is a top left front perspective view of a sensor module showing our new design;

FIG. 2 is a rear elevation view thereof;

FIG. 3 is a front elevation view thereof;

FIG. 4 is a right side elevation view thereof;

FIG. 5 is a left side elevation view thereof;

FIG. 6 is a top plan view thereof;

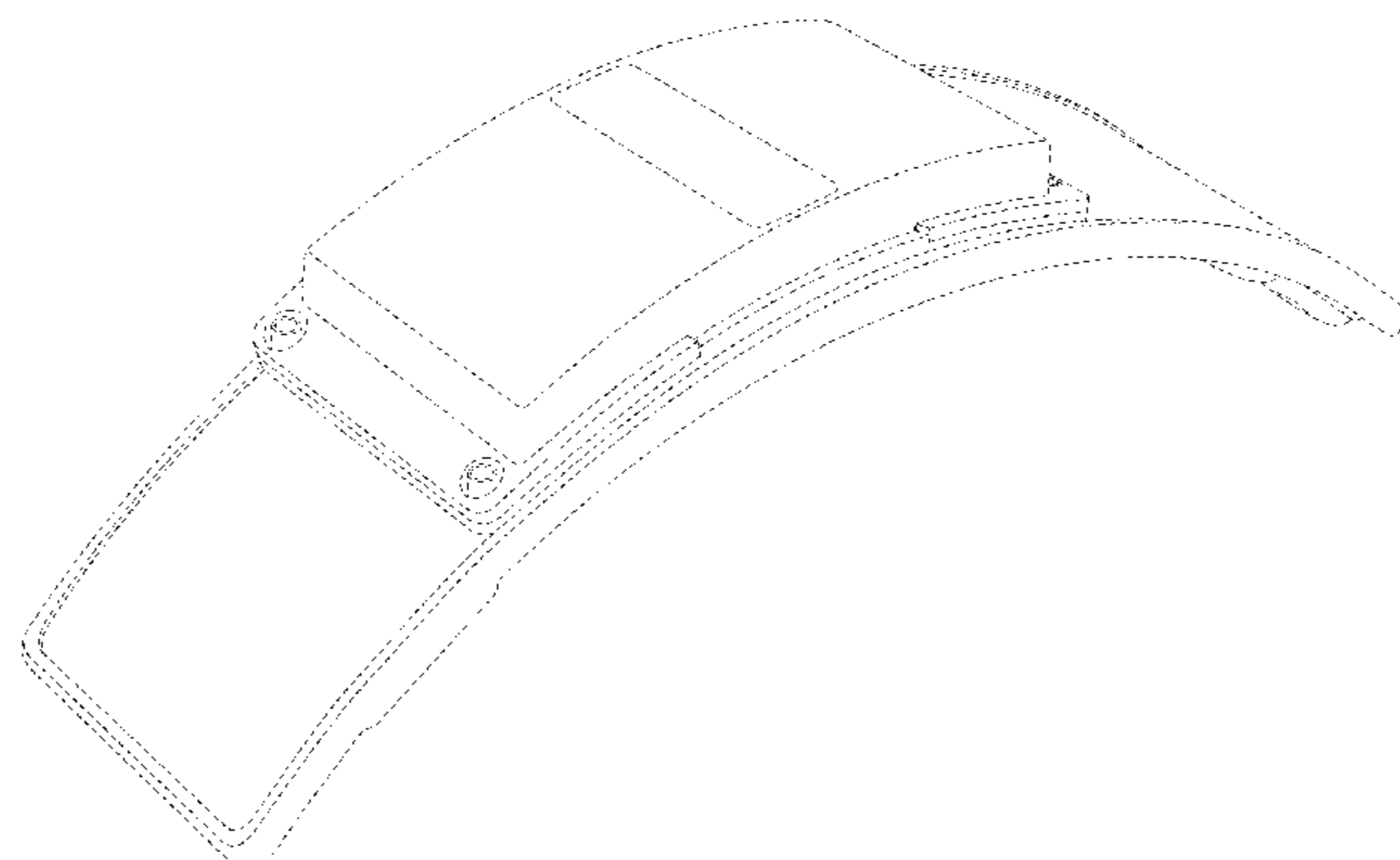
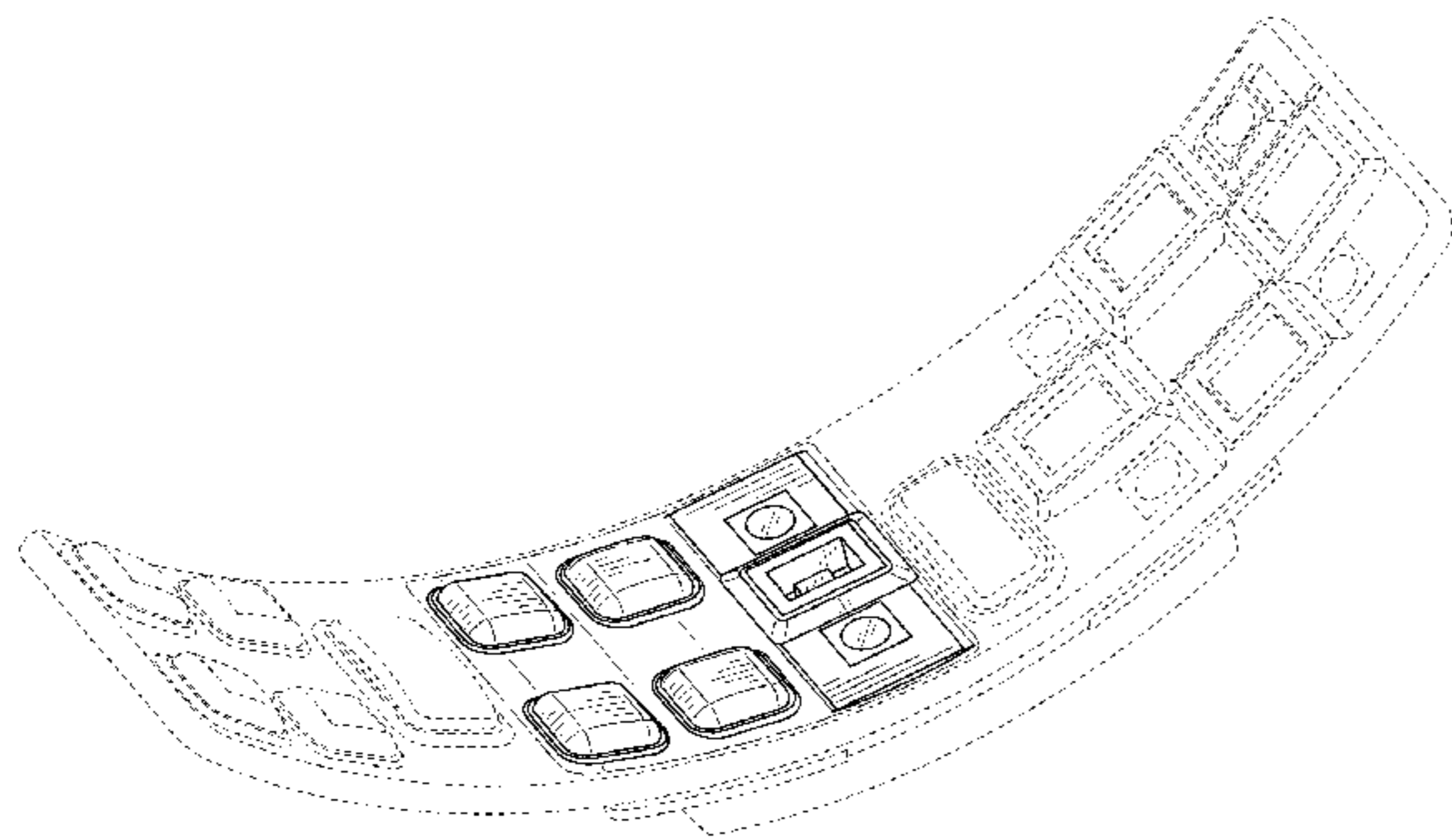
FIG. 7 is a bottom plan view thereof; and,

FIG. 8 is a bottom right rear perspective view thereof.

The even length dashed broken lines are for environmental purposes only and form no part of the claimed design.

The uneven length dot-dash broken lines represent an unclaimed boundary line and form no part of the claimed design.

1 Claim, 5 Drawing Sheets



(56)

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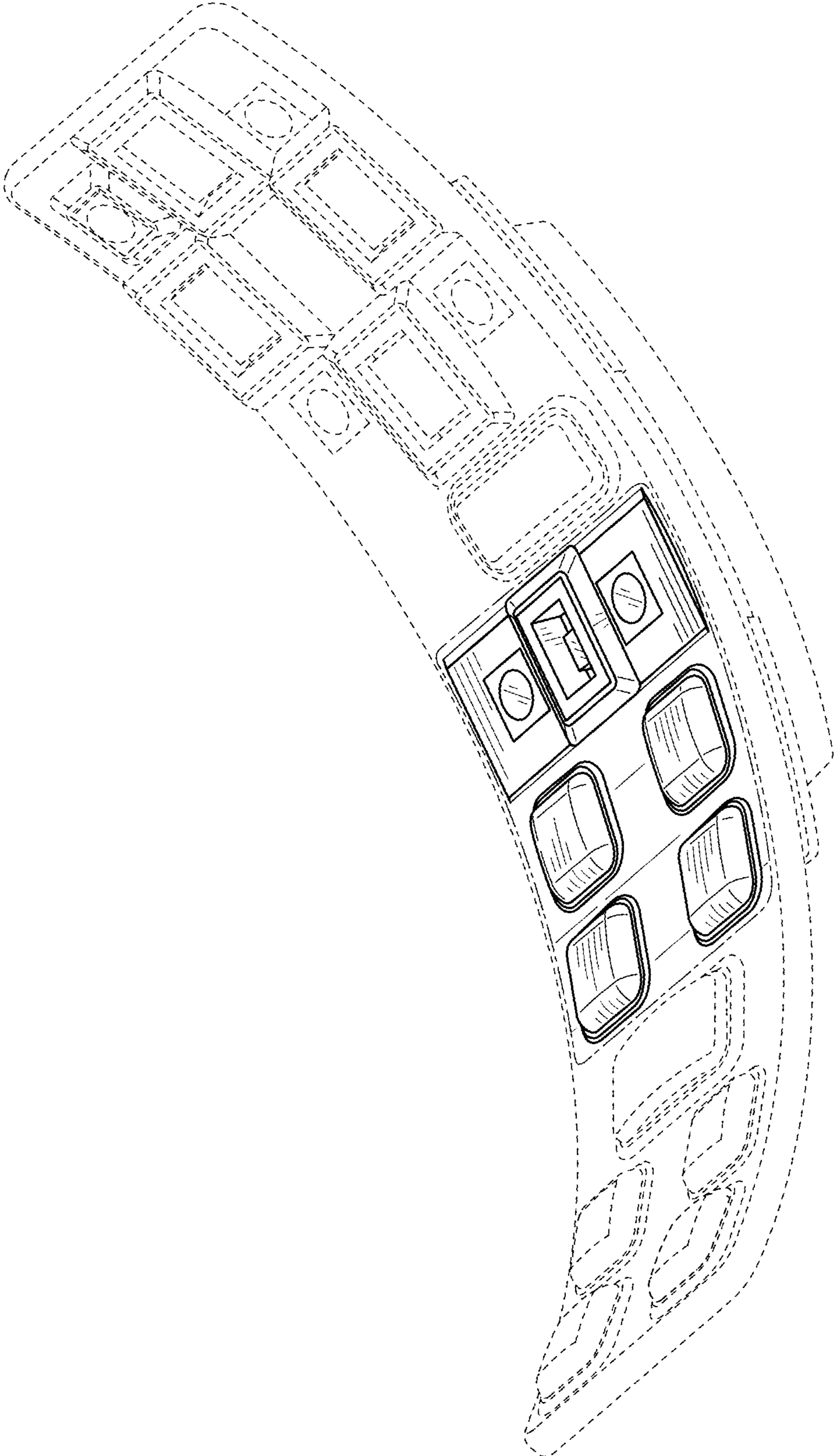


FIG. 1

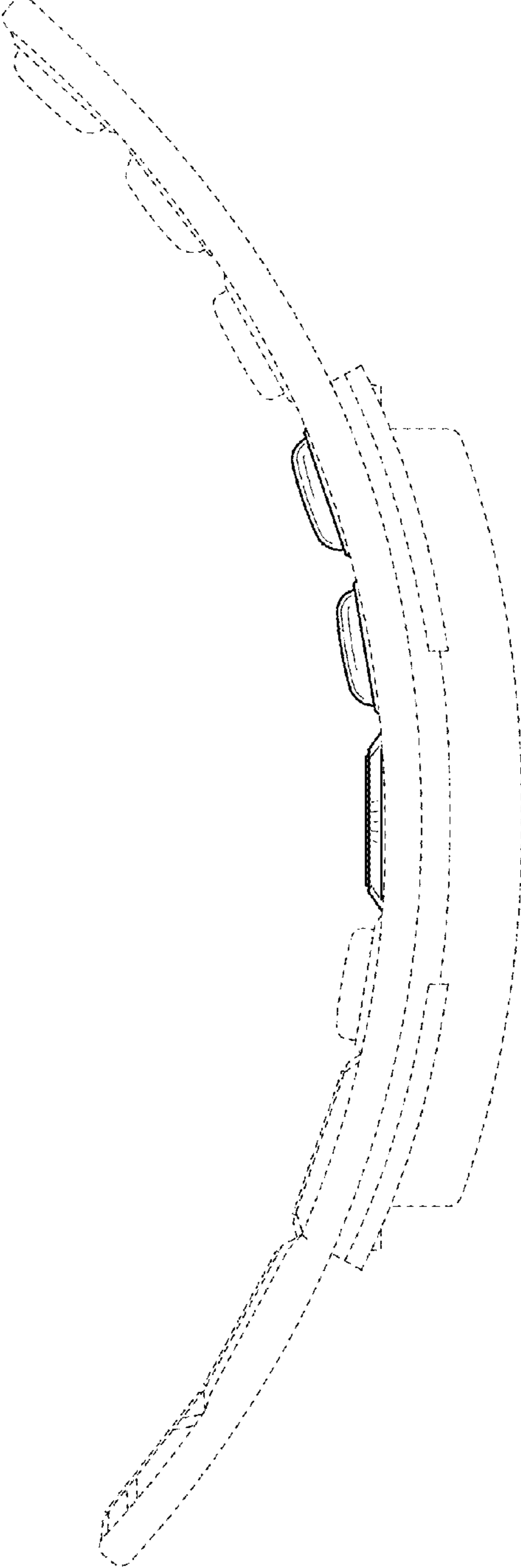


FIG. 2

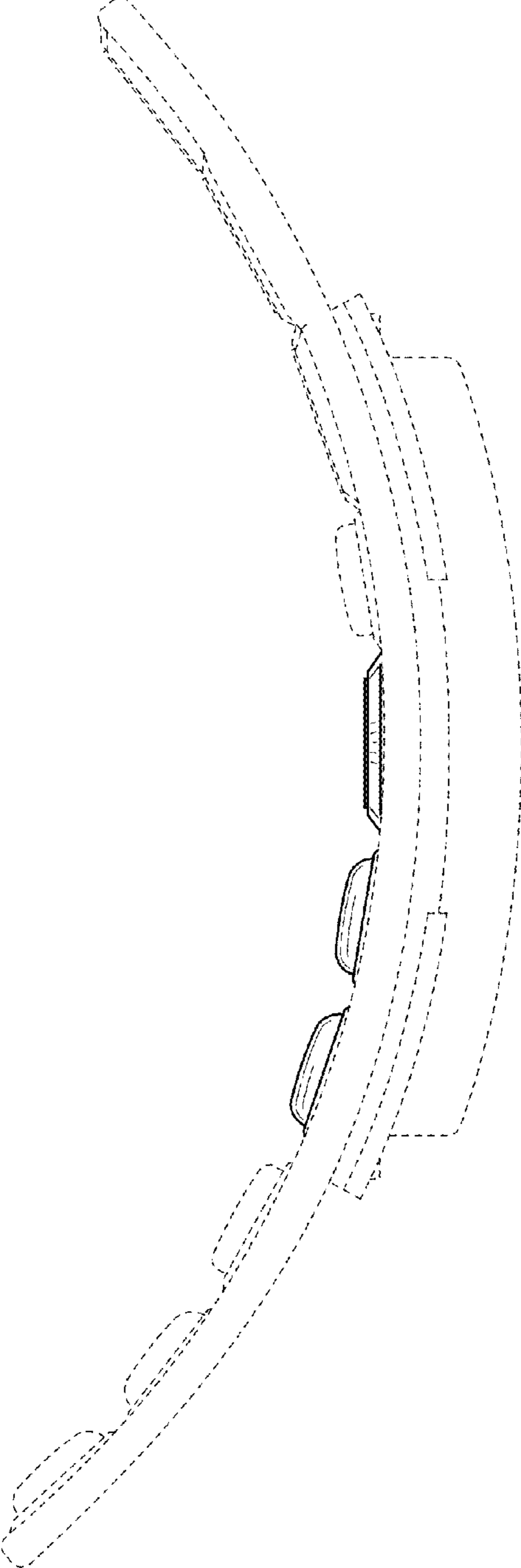


FIG. 3

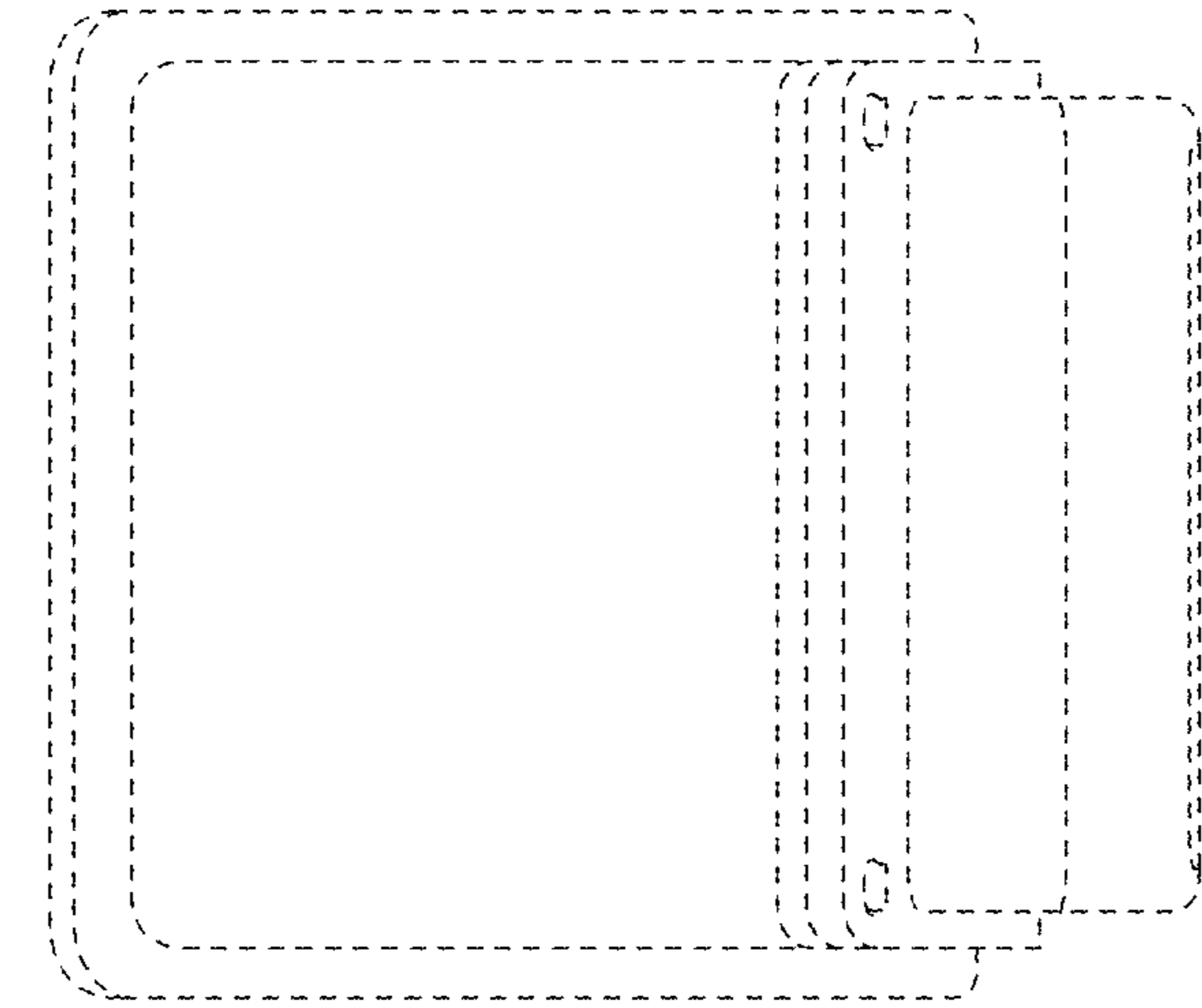


FIG. 5

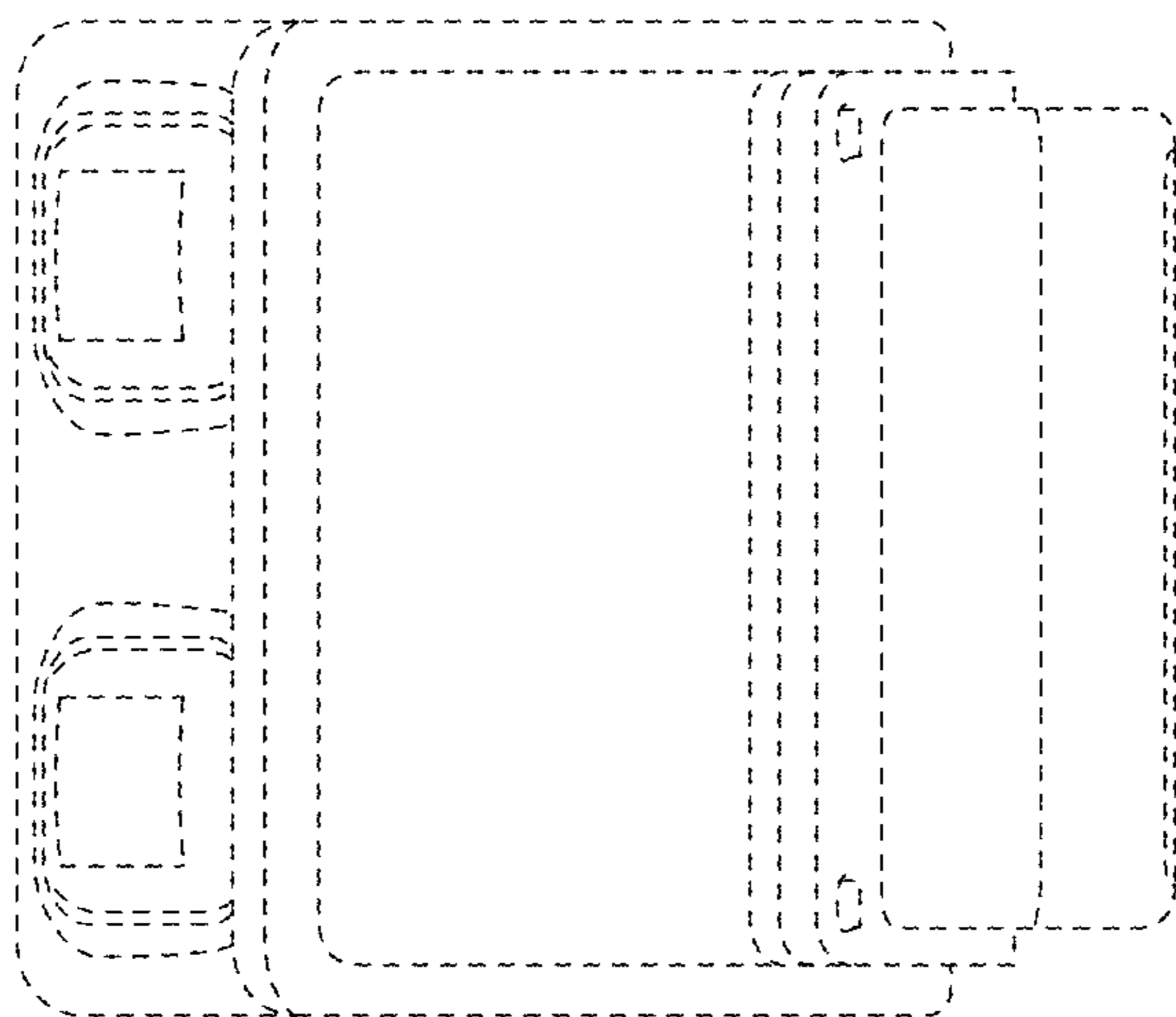


FIG. 4

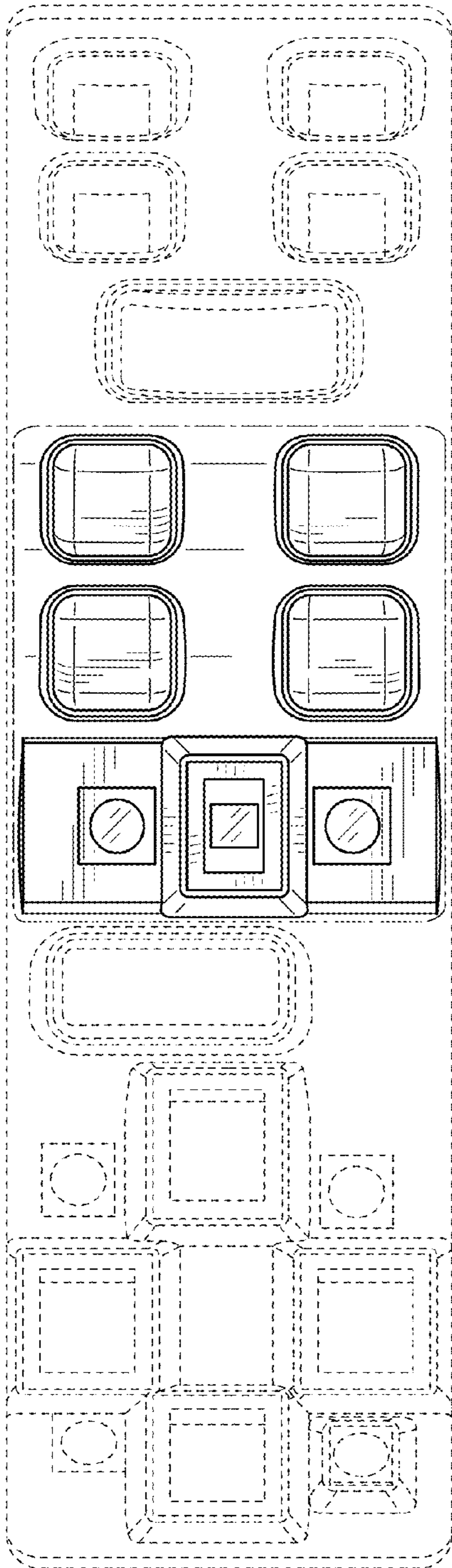


FIG. 6

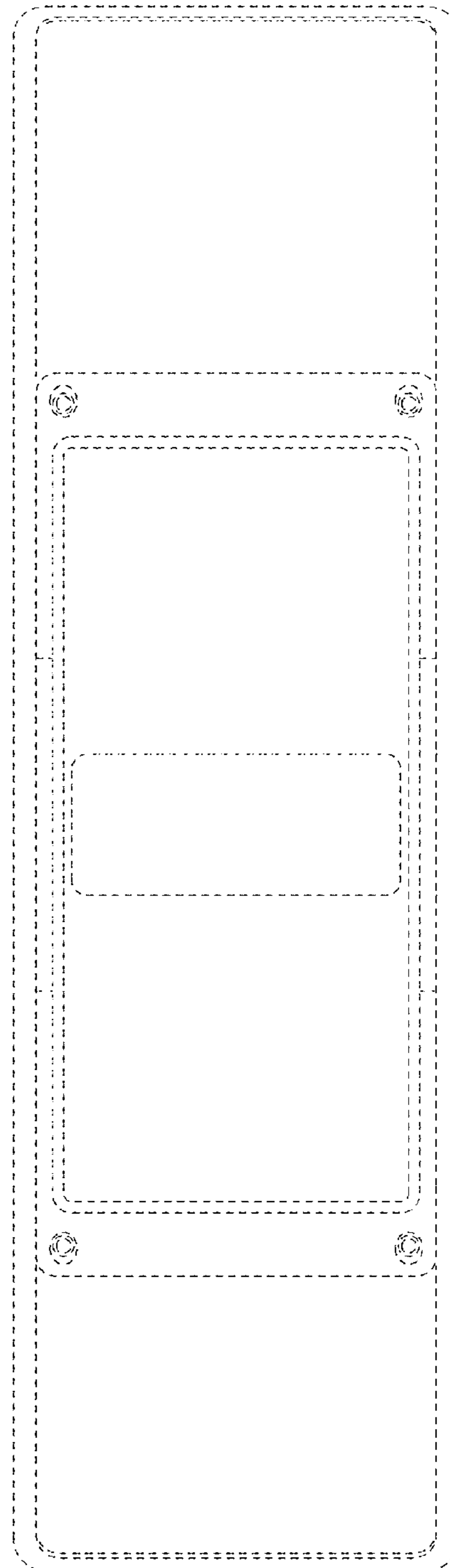


FIG. 7

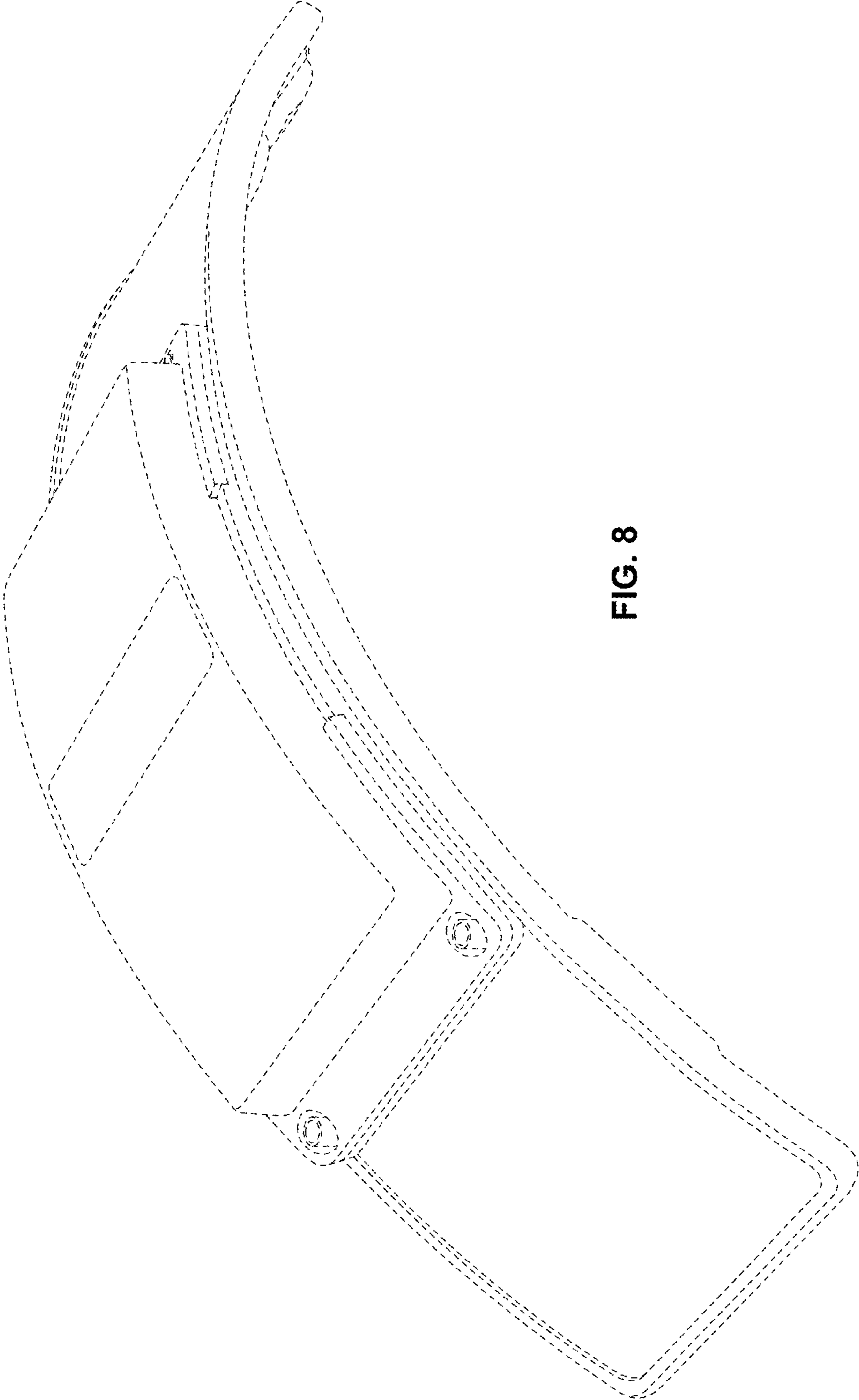


FIG. 8